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## Product Change Notification - JAON-22LUWC382 (Printer Friendly)

**Date:**

09 May 2017

**Product Category:**

KEELOQ® Encoder Devices; Interface- Passive-Keyless-Entry Analog Front End; Successive Approximation Register (SAR) A/D Converters; Digital Potentiometers; Linear Op Amps; Linear Comparators; 8-bit PIC Microcontrollers

**Notification subject:**

CCB 1657 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 120K wafer technology available in 14L TSSOP package at MMT assembly site

**Notification text:****PCN Status:**

Final notification

**Microchip Parts Affected:**

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 120K wafer technology available in 14L TSSOP package at MMT assembly site.

**Pre Change:**

Palladium coated copper wire (PdCu)

**Post Change:**

Palladium coated copper wire with gold flash (CuPdAu)

**Impacts to Data Sheet:**

None

**Reason for Change:**

To improve manufacturability and qualify palladium coated copper with gold flash (CuPdAu) bond wire.

**Change Implementation Status:**

In Progress

**Estimated First Ship Date:**

November 23, 2015 (date code: 1548)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Summary Table:**

	July 2015	August 2015	September 2015	October 2015	November 2015
Initial PCN Issue Date	X				
Qual Report Availability				X	
Final PCN Issue Date				X	

Implementation Date						X
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**Markings to Distinguish Revised from Unrevised Devices:**

Traceability code

**Revision History:****July 07, 2015:** Issued initial notification.**October 16, 2015:** Issued final notification. Attached the qualification report. Revised the estimated first ship date from October 20, 2015 to November 23, 2015.**May 09, 2017:** Updated the affected CPN list.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**[PCN\\_JAON-22LUWC382\\_Qual\\_Report1.pdf](#)[PCN\\_JAON-22LUWC382\\_Affected\\_CPN1.pdf](#)[PCN\\_JAON-22LUWC382\\_Affected\\_CPN1.xls](#)

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